

STEPPER MOTOR DRIVE CIRCUIT

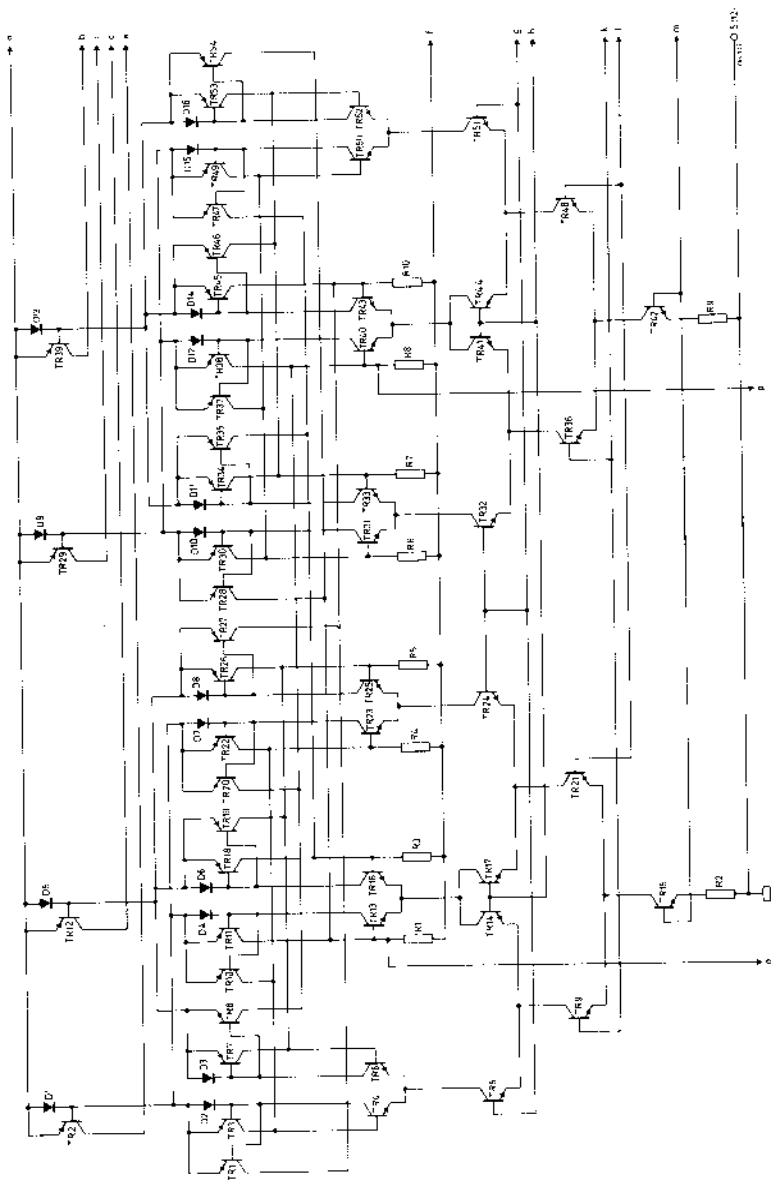
The SAA1027 is intended for driving a four phase two stator stepper motor. The circuit consists of four output stages, a logic part and three input stages. The logic part is driven by three input stages; a trigger input stage, an input stage which can change the switching sequence of the logic part so that the motor can rotate clock wise (CW) or counter clock wise (CCW) and a set input stage to set the four output stages. The three inputs are compatible with high noise immunity logic to ensure proper operation, even in noisy environments. The output can deliver 350 mA in each phase. The right switching sequence of the four phases is obtained from the logic part of the circuit. Integrated diodes protect the outputs against transient spikes.

QUICK REFERENCE DATA

Supply voltage	V_p	9, 5 to 18	V
Load current (each output)	I_Q	max.	350 mA
Logic for CW and CCW operation			

PACKAGE OUTLINE 16 lead plastic power dual in-line (see page 9)

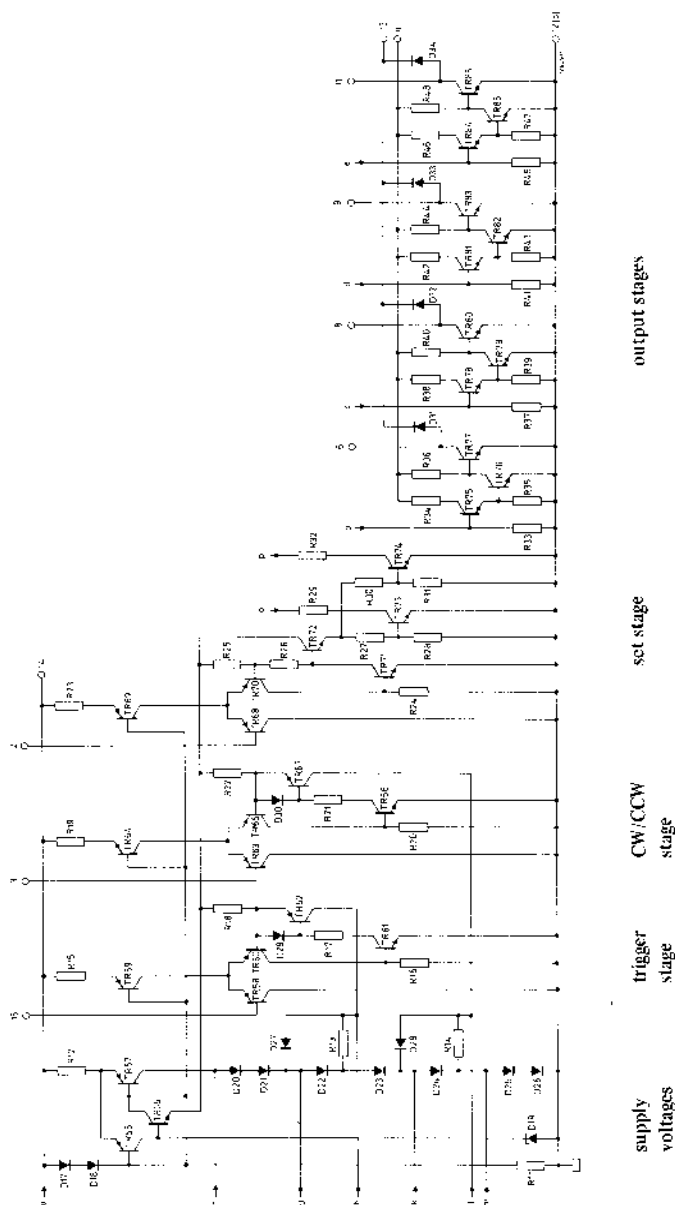
CIRCUIT DIAGRAM



bi-directional, 4 position, synchronous counter

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RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Supply voltage (pins 4, 13, 14)

V_P max. 20 V

Input voltage; R (pin 3), S (pin 2), T (pin 15)

V_I max. 20 V

Current

Output current; Q_1 (pin 6), Q_2 (pin 8), Q_3

I_Q max. 500 mA

Power dissipation

see derating curve below 1)

Temperatures

Storage temperature

T_{stg} -40 to +125 °C

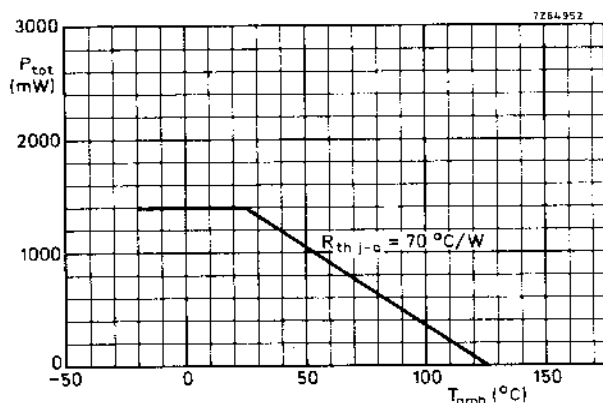
Operating ambient temperature

T_{amb} -20 to +70 °C

THERMAL RESISTANCE

From junction to ambient

$R_{th j-a}$ 70 °C/W



1) Additional power caused by the self-inductance of the motor-coils will be dissipated in the diodes (D31 to D34).

This extra dissipation has not been considered in the bottom graph on page 8.
If necessary external diodes must be used.

FUNCTION TABLE

Direction conditions (R)

The direction of rotation can be changed at any moment independent of the state of the T and S inputs.

Set conditions (S)

When T is HIGH and S LOW then the outputs are set: $Q_1 = L$, $Q_2 = H$, $Q_3 = L$, $Q_4 = H$.

Trigger conditions (T)

S = H									
R = H					R = L				
T	Q ₁	Q ₂	Q ₃	Q ₄	T	Q ₁	Q ₂	Q ₃	Q ₄
0	L	H	L	H	0	L	H	L	H
1	H	L	L	H	1	L	H	H	L
2	H	L	H	L	2	H	L	H	L
3	L	H	H	L	3	H	L	L	H
4	L	H	L	H	4	L	H	L	H

CHARACTERISTICS at $T_{amb} = -20$ to $+65$ °C: $V_P = 12$ V

Supply voltage (pin 14)

V_P typ. 12 V
9.5 to 18 V

Supply current (without load, all inputs
HIGH, pin 4 open)

I_P typ. 4,5 mA
2,0 to 6,5 mA

Input logic voltage levels and currents for R, S and T
HIGH

V_{IH} > 7,5 V
 I_{IH} typ. 1 μ A

LOW

V_{IL} < 4,5 V
 I_{IL} typ. 30 μ A

Supply voltage (each output stage)

V_Q typ. 12 V
1,5 to 18 V

Supply current (each output stage)

I_Q < 350 mA

Saturation voltage of output transistors
at $I_Q = 350$ mA (pins 6, 8, 9, 11)

V_{sat} < 1,0 V

Bias voltage and current (max. values: pin 4)

See top graph on page 7

Bias resistor

See bottom graph on page 7

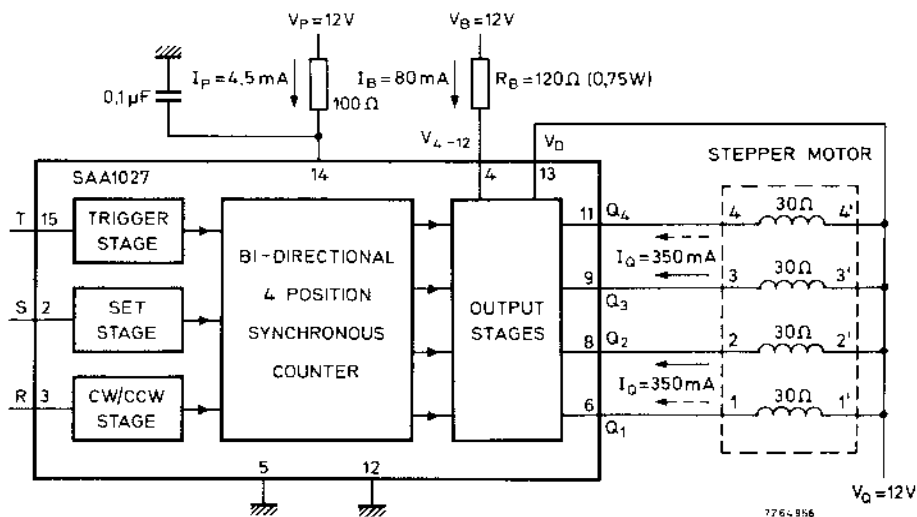
Power dissipation in bias resistor

See top graph on page 8

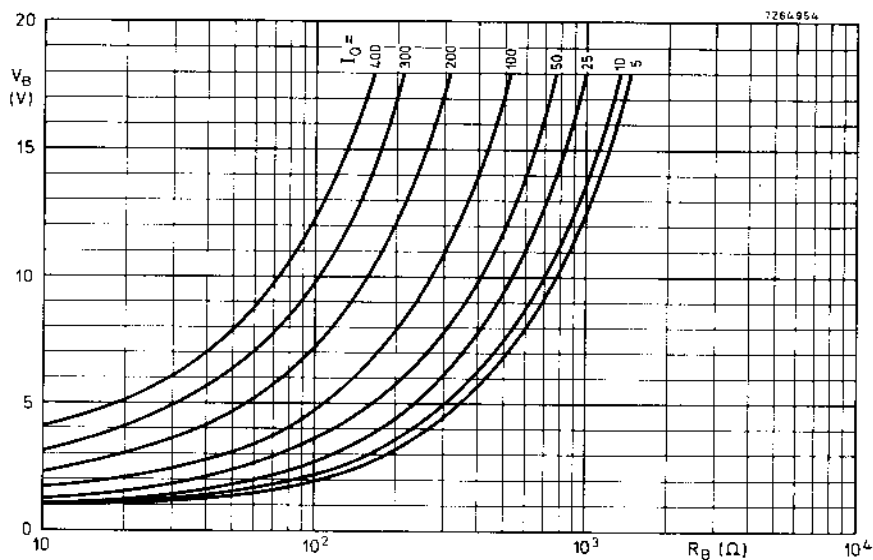
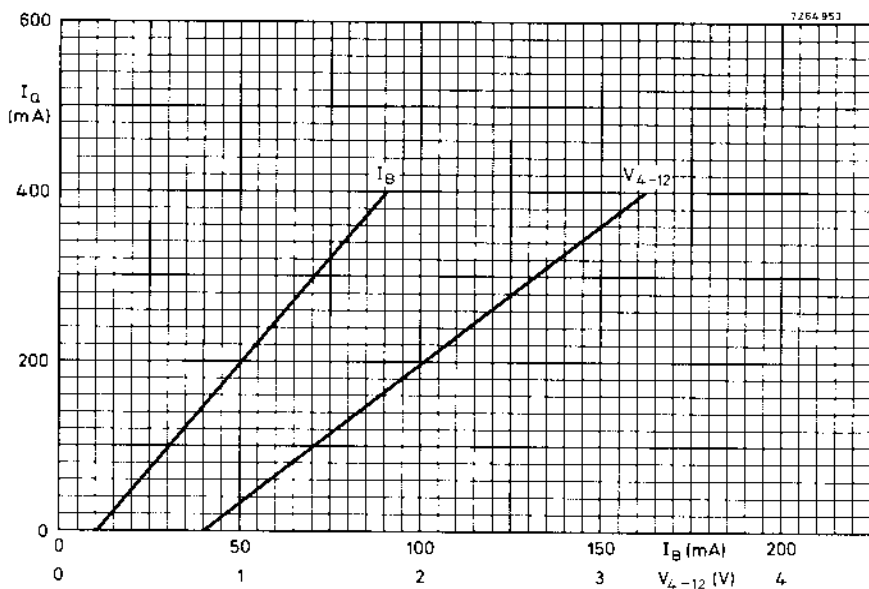
Total device power dissipation

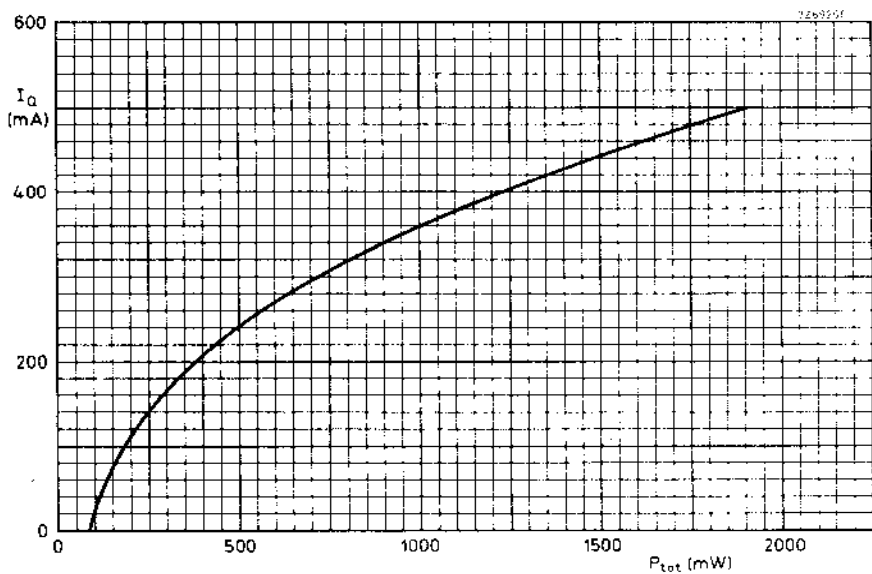
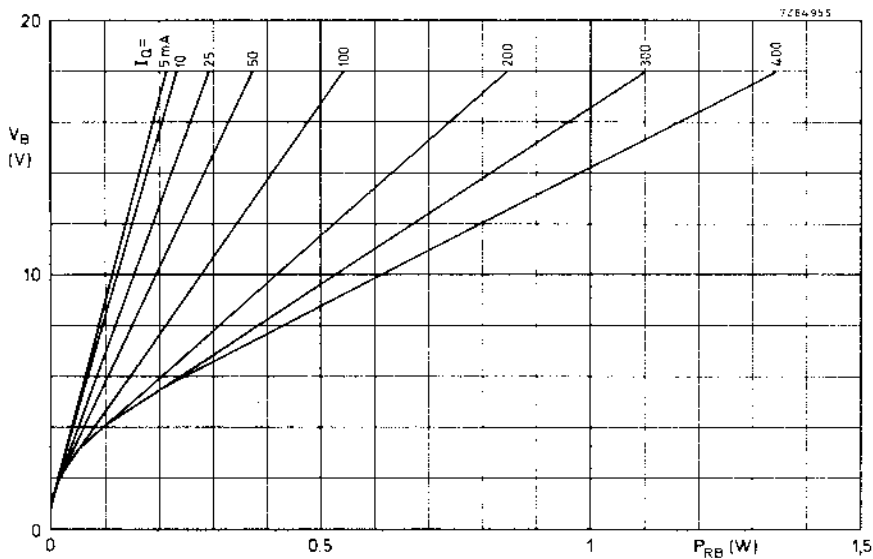
See bottom graph on page 8



APPLICATION INFORMATION

PINNING

- | | |
|-------------------------------------|--------------------------------------|
| 1. not connected | 9. Q ₃ (output) |
| 2. S (set input) | 10. not connected |
| 3. R (CW/CCW input) | 11. Q ₄ (output) |
| 4. V _B (positive supply) | 12. Earth (negative supply) |
| 5. Earth (negative supply) | 13. V _D (positive supply) |
| 6. Q ₁ (output) | 14. V _P (positive supply) |
| 7. not connected | 15. T (trigger input) |
| 8. Q ₂ (output) | 16. not connected |



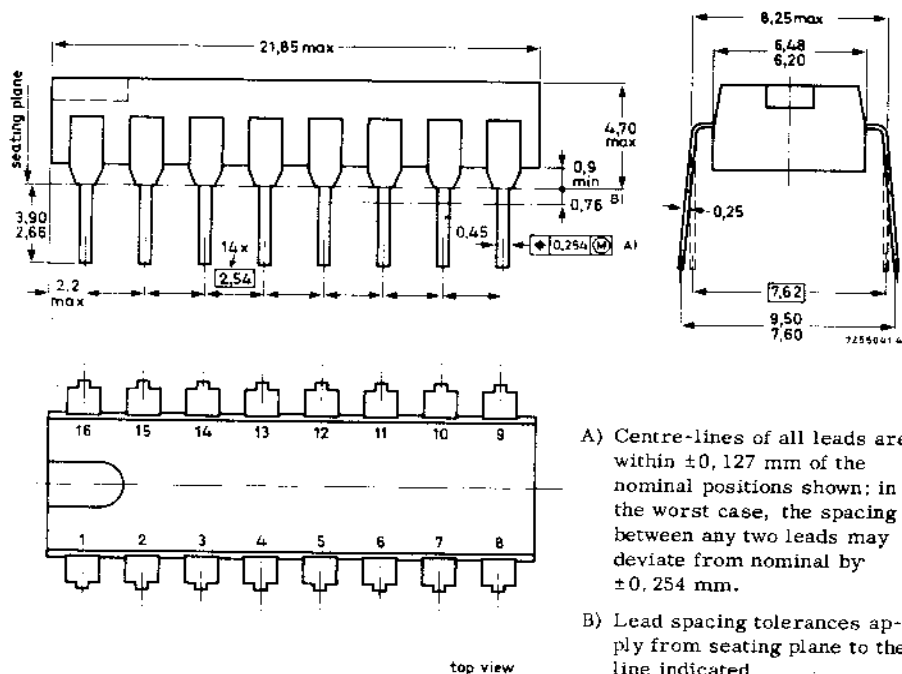


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16 LEAD PLASTIC POWER DUAL IN-LINE

Dimensions in mm



SOLDERING

1. By hand

Apply the soldering iron below the seating plane (or not more than 2 mm above it). If its temperature is below 300 °C it must not be in contact for more than 10 seconds; if between 300 °C and 400 °C, for not more than 5 seconds.

2. By dip or wave

260 °C is the maximum allowable temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified storage maximum. If the printed circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the allowable limit.

3. Repairing soldered joints

The same precautions and limits apply as in (1) above.